



Product Change Notification

Change Notification #: 116593 - 00
Change Title: Intel® Server System R2308WFTZS,
Intel® Server System R2208WFTZS,
Intel® Server System R2224WFTZS,
PCN 116593-00, Product Design,
Riser Card change
Date of Publication: November 13, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	November 28, 2018
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Systems listed in the "Products Affected" table below:

The Riser Card #3 A2UX8X4RISER has implemented SMBus support.

- PBA for Riser Card has been changed from G94347-171 to G94347-271

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2308WFTZS	975887	H97457-009	H97457-010
R2208WFTZS	975889	H97440-009	H97440-010
R2224WFTZS	975895	H97447-008	H97447-009

PCN Revision History:

Date of Revision: November 13, 2018	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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